

### CMOS 8-Channel Data Selector

High-Voltage Types (20-Volt Rating)

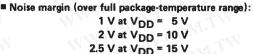
■ CD4512B is an 8-channel data selector featuring a three-state output that can interface directly with, and drive, data lines of bus-oriented systems.

The CD4512B-series types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (M, M96, MT, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

### 勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-54151736 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

### Features:

- # 3-state output
- Standardized, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- 5-V, 10-V, and 15-V parametric ratings
- Maximum input current of 1 μA at 18 V over full packagetemperature range; 100 nA at 18 V and 25°C



Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

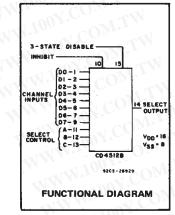
Applications:

- Digital multiplexing
- Number-sequence generation
- Signal gating

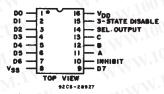
#### RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

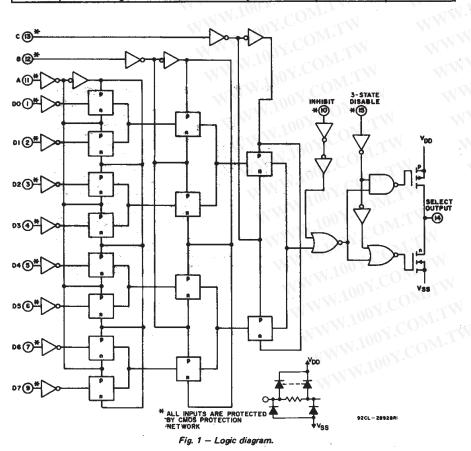
M.100 .	LIM		
CHARACTERISTIC	MIN.	MAX.	UNITS
Supply-Voltage Range (For T <sub>A</sub> = Full Package Temperature Range)	301	18	v



CD4512B Types

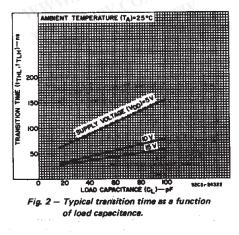


TERMINAL ASSIGNMENT



**TRUTH TABLE** SEL. CONT. 3-STATE SEL NH В С DISABLE OUTPUT Α 0 0 0 0 0 D0 0 0 0 0 D1 1 0 0 1 0 0 D2 1 1 0 0 0 D3 0 0 1 0 0 **D4** 0 1 0 0 **D**5 1 0 1 1 0 0 **D6** 1 1 0 0 D7 х х X 1 0 0 x Х X X 1 High Z 1 = High Level 0 = Low Level

X = Don't Care



# CD4512B Types

WWW.1001.COM.1		胜胜
WWW.100Y.CONLTW WWW	V100X.COLUMITW	
MAXIMUM RATINGS, Absolute-Maximum Values:		
DC SUPPLY-VOLTAGE RANGE, (VDD)		
Voltages referenced to V <sub>SS</sub> Terminal) INPUT VOLTAGE RANGE, ALL INPUTS	-0.5V to +20	1
INPUT VOLTAGE RANGE, ALL INPUTS		1
DC INPUT CURRENT, ANY ONE INPUT	±10m/	A
POWER DISSIPATION PER PACKAGE (PD):	1002	
For T <sub>A</sub> = -55°C to +100°C		1
For $T_A = -55^{\circ}C$ to $+100^{\circ}C$ For $T_A = +100^{\circ}C$ to $+125^{\circ}C$ DEVICE DISSIPATION PER OUTPUT TRANSISTOR	. Derate Linearity at 12mW/ <sup>O</sup> C to 200mW	V
FOR TA = FULL PACKAGE-TEMPERATURE RANGE (All Package Typ	oes)	, I
OPERATING-TEMPERATURE RANGE (TA)		S
STORAGE TEMPERATURE RANGE (Tstg) LEAD TEMPERATURE (DURING SOLDERING):		2
At distance 1/16 $\pm$ 1/32 inch (1.59 $\pm$ 0.79mm) from case for 10s max .	+265°0	2



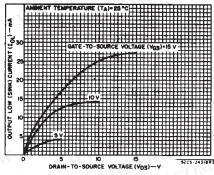
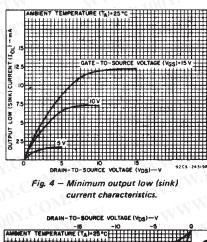
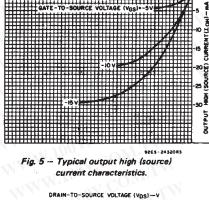


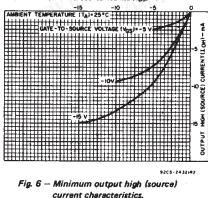
Fig. 3 - Typical output low (sink) current characteristics.

#### STATIC ELECTRICAL CHARACTERISTICS

CHARAC- TERISTIC	CONDITIONS			LIMITS AT INDICATED TEMPERATURES (°C)							U N I T
Quiescent	Vo	VIN	VOD	Inal	1 CO		N	+25			s
	- (V)	(V)	(V)	55	-40	+85	+125	Min.	Тур.	Max.	
		0,5	5	5	5	150	150	-	0.04	5	00
Device		0,10	10	10	10	300	300	-	0.04	10	μA
Current,	-	0,15	15	20	20	600	600		0.04	20	
	_	0,20	20	100	100	3000	3000		0.08	100	N.1
Output Low	0.4	0,5	5	0.64	0.61	0.42	0.36	0.51	1	17	
(Sink) Current	0.5	0,10	10	1.6	1.5	< G.1	0.9	1.3	2.6	0ŦV	
IOL Min.	1.5	0,15	15	4.2	4	2.8	2.4	3.4	6.8	-51	N
Output High	4.6	0,5	5	-0.64	0.61	-0.42	-0.36	-0.51	-1		mA
(Source)	2.5	0,5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2		
Current, <sup>1</sup> OH <sup>Min.</sup>	9.5	0,10	10	. –1.6	-1.5	-1.1	-0.9	-1.3	-2.6		N
OH WITT	13.5	0,15	15	-4.2	-4	-2.8	-2,4	-3.4	-6.8	-	
Output Voltage:	_	0,5	5		0.	05	1.	0	0.05	1	
Low-Level,	_	0,10	10		0.	05		0	0.05		
V <sub>OL</sub> Max.		0,15	15		0.	$\overline{\Delta_{\Sigma_{1}}}$	0	0.05	v		
Output	_	0,5	5		4.	4.95	5	<u>.</u>			
Voltage:	_	0,10	10	9.95					10	-	
High-Level, V <sub>OH</sub> Min.	_	0,15	15		14	14.95	1.	- 5			
	0.5,4.5		5					1.5			
Input Low Voltage	1,9	_	10	3					102.	3	
V <sub>IL</sub> M̃ax.	1.5,13.5	_	15	4				10 - 1	-02	4	V
Input High	0.5,4.5	_	5					3.5		12	
Voltage,	1,9		10			7		-	N		
VIH Min.	1.5,13.5	_	15		- Vielander van de la companya de la Companya de la companya	11	11		·\$-		
Input Current I <sub>IN</sub> Max.	_	0,18	18	±0.1	±0.1	<b>‡1</b>	<b>*</b> 11		±10 <sup>-5</sup>	±0.1	μA
3-State Output Leakage Current IOUT Max.	0,18	0,18	18	±0.4	±0.4	±12	±12		±10 <sup>-4</sup>	±0.4	μΑ







3

### CD4512B Types

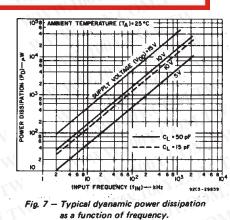
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# DYNAMIC ELECTRICAL CHARACTERISTICS at T<sub>A</sub> = 25°C, Input t<sub>r</sub>,t<sub>f</sub> = 20 ns, C<sub>L</sub> = 50 pF, R<sub>L</sub> = 200 k $\Omega$

CHARACTERISTIC	TEST CONDITIONS	LIMITS		UNITS	
WWW.100Y.COM.T	V <sub>DD</sub> (V)	Тур.	Max.	CITI	
Propagation Delay Time, tpHL, tpLH Inhibit to Output	5 10 15	140 70 50	280 140 100 400 170 120 360 150 110	OM.T	
"A" Select to Output	5 10 15	200 85 60 180 75 55		ns	
Data to Output	5 10 15				
3-State Disable Delay Time: <sup>t</sup> PZL, <sup>t</sup> PLZ, <sup>t</sup> PHZ, <sup>t</sup> PZH	5 10 15	60 30 20	120 60 40	ns	
Transition Time, t <sub>THL</sub> , t <sub>TLH</sub>	5 10 15	100 50 40	200 100 80	ns	
Input Capacitance, C <sub>IN</sub> (Any Input)	OOY.COM.TW	5	7.5	pF	



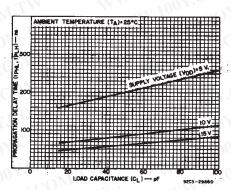
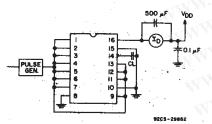


Fig. 8 – Typical propagation delay time as a function of load capacitance ("A" select to output).



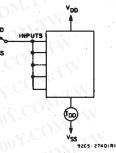
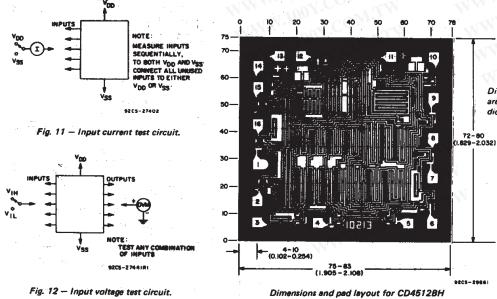


Fig. 9 - Dynamic power dissipation test circuit.

Fig. 10 - Quiescent device current test circuit.



Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils ( $10^{-3}$  inch).



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# PACKAGE OPTION ADDENDUM

18-Jul-2006

### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3</sup>
CD4512BE	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
CD4512BEE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
CD4512BF	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
CD4512BF3A	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
CD4512BM	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4512BM96	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD4512BM96E4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD4512BME4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD4512BMT	ACTIVE	SOIC	D	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD4512BMTE4	ACTIVE	SOIC	TND	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD4512BNSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD4512BNSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD4512BPW	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD4512BPWE4	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD4512BPWR	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD4512BPWRE4	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined. Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

## PACKAGE OPTION ADDENDUM



18-Jul-2006

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J (R-GDIP-T\*\*)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE

PINS \*\* 14 16 18 20 DIM 0.300 0.300 0.300 0.300 Α (7,62) (7,62) (7,62) (7,62) BSC BSC BSC BSC 14 8 0.785 .840 0.960 1.060 B MAX (19, 94)(21, 34)(24, 38)(26, 92)B MIN С 0.300 0.300 0.300 0.310 С MAX (7, 62)(7, 62)(7, 87)(7, 62)0.245 0.245 0.220 0.245 C MIN 0.065 (1,65) (6, 22)(6, 22)(5, 59)(6, 22)0.045 (1,14) 0.060 (1,52) ◀— 0.005 (0,13) MIN Α 0.015 (0,38) 0.200 (5,08) MAX Seating Plane 0.130 (3,30) MIN 0.026 (0,66) 0.014 (0,36) 0'-15' 0.100 (2,54) 0.014 (0,36) 0.008 (0,20) 4040083/F 03/03

NOTES: A. All linear dimensions are in inches (millimeters).

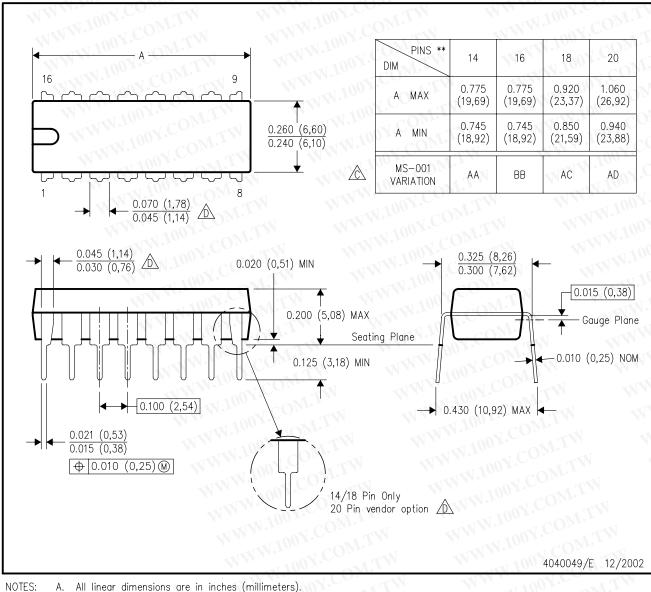
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

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# W.100Y.COM. **MECHANICAL DATA**

N (R-PDIP-T\*\*) 16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



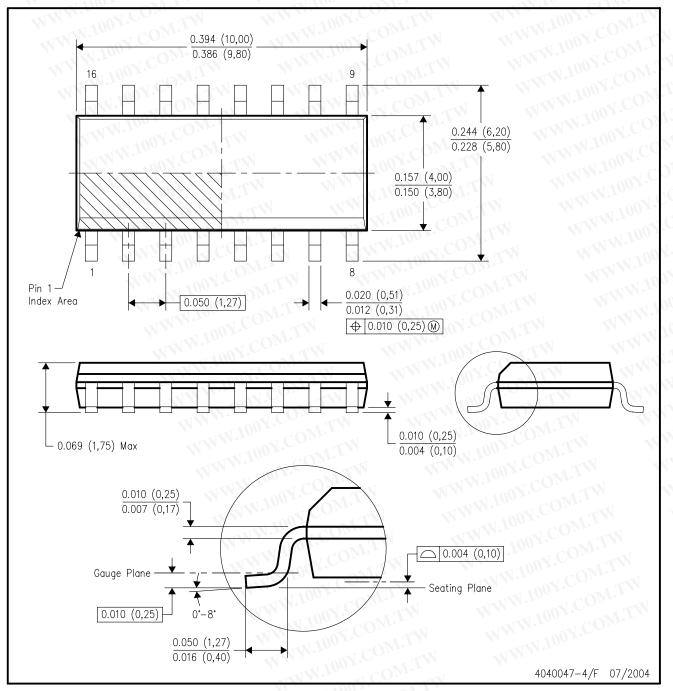
- Α.
- All linear dimensions are in inches (millimeters). B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width. /b\ WWW.100Y.COM.TW WWW.100Y.





D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AC.





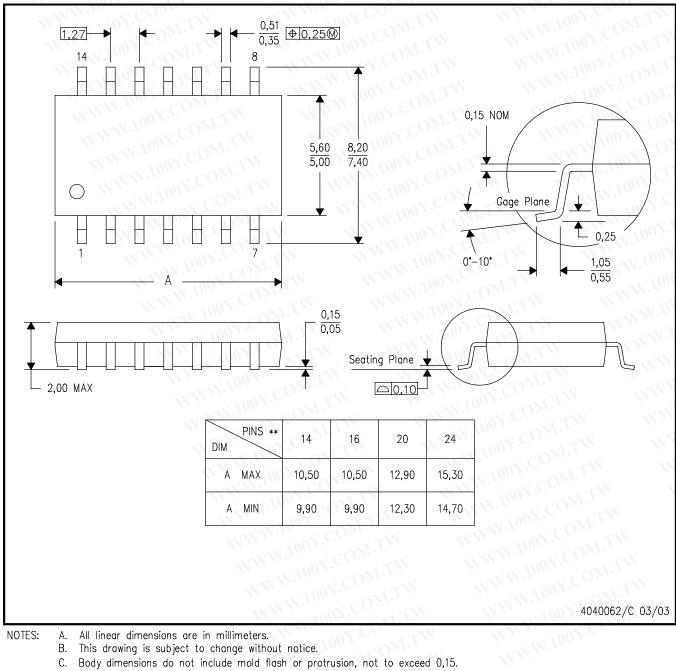
**MECHANICAL DATA** 

PLASTIC SMALL-OUTLINE PACKAGE

WW.100Y.COM

NS (R-PDSO-G\*\*) **14-PINS SHOWN** 

WWW.100Y.C



NOTES: All linear dimensions are in millimeters. Α.

- Β. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15. WWW.100Y.C



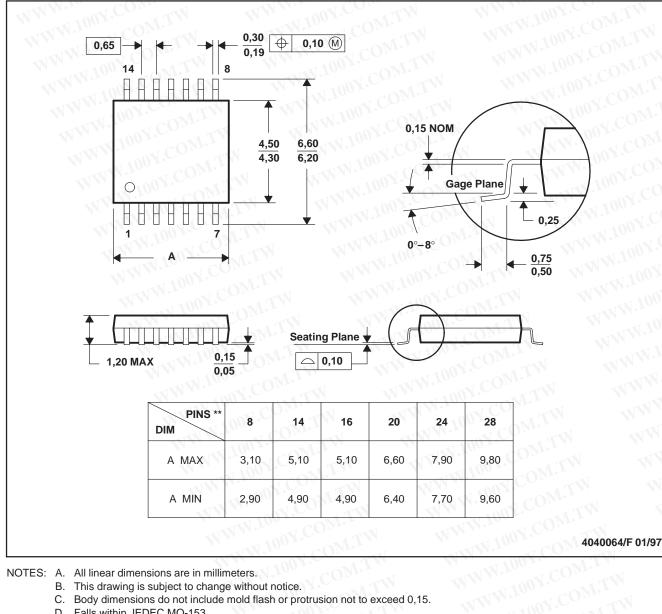
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### **MECHANICAL DATA**

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

### PW (R-PDSO-G\*\*) **14 PINS SHOWN**

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- Β. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153

